

- Enhanced protection of wafer surfaces
- Minimizes lateral movement without applying compression to delicate wafer edges
- Advanced design minimizes particle generation
- Secure 4 latch system (with 2 latch option)
- Impact resistant design
- Large label areas
- Interfaces with industry robotic handling equipment
- Drop-in replacement for old industry designs
- Protective shipping OverPAKs available...[see products](#)



Wafer canister part numbers and ordering information:

Wafer Size	ePAK Description	ePAK Order Code	Internal Diameter	Internal Height	Corner Latches #	Outside Base Size	Std Pack Quantity
6"	eCT-LX6/150-2-44-R.1x	eWB0086-2-x	151 mm	44 mm (1.73")	2	174.5mm x 174.5mm	10/carton
6"	eCT-LX6/150-4-44-R.1-x	eWB0086-4-x	151 mm	44 mm (1.73")	4	174.5mm x 174.5mm	10/carton
6"	eCT-LX6/150-2-44-x	eWB0019-2-x	151 mm	44 mm (1.73")	2	225mm x 225mm	10/carton
6"	eCT-LX6/150-4-44-x	eWB0019-4-x	151 mm	44 mm (1.73")	4	225mm x 225mm	10/carton
8"	eCT-LX8/200-2-44-x	eWB0018-2-x	201 mm	44 mm (1.73")	2	225mm x 225mm	10/carton
8"	eCT-LX8/200-4-44-x	eWB0018-4-x	201 mm	44 mm (1.73")	4	225mm x 225mm	10/carton
8"	eCT-LX-8/200-4-69-X	eWB0383-4-x	200.8 mm	69 mm (2.72")	4	225mm x 225mm	10/carton
12"	eCT-LX12/300-4-44-x	eWB0026-4-x	301.5 mm	44 mm (1.73")	4	326mm x 326mm	12/carton
12"	eCT-LX12/300-4-71-X	eWB0371-4-x	301.2 mm	71 mm (2.79")	4	326mm x 326mm	8/carton

eFORM™ –Clean Adjustable Platform option to minimize vertical movement (–x in P/N):

Wafer Size	ePAK Description	ePAK Order Code	Diameter	Adjustable Height	Std Pack Quantity
6"	eAP6-150-16-x	eOP0042-x	150 mm	16 mm	10/pack
8"	eAP8-200-16-x	eOP0041-x	200 mm	16 mm	10/pack
12"	eAP12-300-16-x	eOP0045-x	300 mm	16 mm	10/pack



Material code options (–x in P/N):

Material	Code	SR
Conductive PP	eM-01-BLK	10e4-10e5

-A wide range of cushion disks and wafer separators are available-

(PATENTS: US #6988620, PRC #ZL 03 2 07820 X, Singapore #106157, Taiwan # I299315, Japan #4383808)

[RETURN TO TABLE OF CONTENTS](#)